



Product Change Notification

Change Notification #: 116499 - 00

Change Title: Select Intel® Data Center Blocks for Cloud, VRN2224BPHY6, VRN2208WFHY6, VRN2224BPAF6, VRN2208WFAF81, VRN2208WFAF82, VRN2208WFAF83, PCN 116499-00, Product Design, Order Code, Replacing select end of life Intel SSD components

Date of Publication: September 24, 2018

Key Characteristics of the Change:

Product Design, Order Code

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	October 22, 2018
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel Corporation is implementing the following change to the Intel® Data Center Blocks for Cloud:

Replacing end of life Intel SSDs with new models for VRN2224BPHY6, VRN2208WFHY6, VRN2224BPAF6, VRN2208WFAF81, VRN2208WFAF82 and VRN2208WFAF83:

- Intel® SSD DC S4500 with Intel® SSD D3 S4510
- Intel® SSD DC S4600 with Intel® SSD D3 S4610
- Intel® SSD DC P4500 with Intel® SSD DC P4510
- Intel® SSD DC P3100 with Intel® SSD DC P4101

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the changes and determine the impact on their applications.

The date of "Customer Must be Ready to Receive Post-Conversion Material" is the projected date that customers must be prepared to start receiving the Post-Converted Material. After this date, the Pre-Conversion SKUs will be discontinued and no longer guaranteed. They may be available only on a first come first serve basis, while supply lasts.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	Pre Change MM#	Post Change MM#
VRN2208WFAF83	961057	999A63
VRN2208WFAF82	961058	9999PG
VRN2208WFAF81	961061	9999PH
VRN2224BPAF6	961104	9999PF
VRN2224BPHY6	961114	999A64
VRN2208WFHY6	962688	9999PJ

PCN Revision History:

Date of Revision:
September 24, 2018

Revision Number:
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Reason:
Originally Published PCN



Product Change Notification

116499 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

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